Requirements for Submission of T&F Proposals in Hard Copy

1. General

1.1. If you wish to be submit hard copy in addition to the electronic submission, you must deposit your T&F Proposals in the respective locations before the close of submission.

1.2. You should submit:

- One copy of your **Technical Proposal** in a **sealed envelope** to [insert post of public officer, project office and department] at [insert address of project office] and
- One copy your **Fee Proposal** in a **sealed envelope** clearly indicating the consultants' name and project reference to the [EACSB Tender Box] located at [the reception on 15/F, Civil Engineering and Development Building, 101, Princess Margaret Road, Homantin, Kowloon] [note to project office: amend for AACSB consultancies] for the attention of the Chairman of [EACSB] [note to project office: amend for AACSB consultancies].
- The information below shall be marked on the sealed envelopes:

Chairman, EACSB
Director of Civil Engineering and Development
15/F, Civil Engineering and Development Building
101, Princess Margaret Road
Ho Man Tin, Kowloon

"EACSB Fee Proposal for Agreement No. [insert agreement no. and title], submitted by _______."

Chairman, AACSB
Director of Architectural Services
35/F, Queensway Government Offices
66 Queensway
Hong Kong

"AACSB Fee Proposal for Agreement No. [insert agreement no. and title], submitted by _______.".

2. Technical Proposal

- 2.1. The Technical Proposal should comply with the conditions as stipulated in the **Guidelines on Preparation of Technical Proposal**.
- 2.2. The Technical Proposal including the attachments shall be inexpensively bound and printed on both sides. For non-compliance with any formatting requirements specified in paragraph (10) in Part (C) of the **Guidelines on Preparation of Technical Proposal** (e.g. printing on both sides), [one mark] shall be deducted from the overall technical score.

3. Fee Proposal

3.1. The Fee Proposal should comply with the conditions as stipulated in the **Guidelines on Preparation of Fee Proposal**.